



# **PRODUCT DATASHEET**



- ► PCB / CHIP LED
- ▶ 1206 (3015) 1.4t
- Green (520nm)



# <u>1206 (3015) 1.4t</u>



# **FEATURES:**

- Package: PCB / CHIP LED Top View
- Forward Current: 20mA
- Forward Voltage (typ.): 2.7V
- Luminous Intensity (typ.): 3500mcd@20mA
- Colour: True Green
- Wavelength (typ.): 520nm
- Viewing angle: 40°
  - Materials:
    - Die: InGaN
    - Resin: Epoxy (Water Clear)
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+85°C
- Grouping parameters:
  - Forward voltage
  - Luminous intensity
  - Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.3000/reel, ø180mm (7")

N0G60S46

1206 (3015) 1.4t

- **APPLICATIONS:**
- Indication Light
- Switch Light
- 3C Application



# **CHARACTERISTICS:**

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	30	mA
Peak Forward Current Duty 1/8@1KHz	Ifp	125	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	IR	10	μΑ
Power Dissipation	PD	102	mW
Operating Temperature	Topr	-40~+80	°C
Storage Temperature	T <sub>STG</sub>	-40~+85	°C

### Electrical & Optical Characteristics (Ta=25°C)

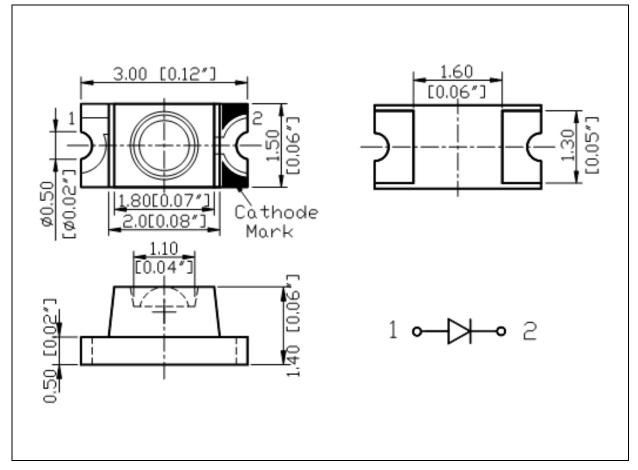
Parameter	Sumbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF	2.5	2.7	3.4	V	I⊧=20mA
Luminous Intensity	Iv	2000	3500	6800	mcd	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{D}$	515	520	525	nm	I⊧=20mA
Peak Wavelength	$\lambda_{P}$		515		nm	I⊧=20mA
Spectral Line Half Bandwidth	Δλ		30		nm	I⊧=20mA
Viewing Angle	20 <sub>1/2</sub>		40		deg	I <sub>F</sub> =20mA

1. Luminous intensity (Iv) ±15%, Forward Voltage (Vr) ±0.1V, Viewing angle(2 $\theta_{1/2}$ ) ±5%

# **OUTLINE DIMENSION:**

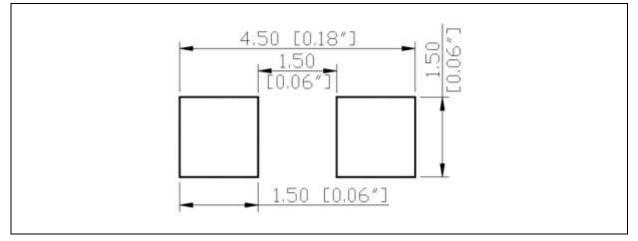


## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



# **BINNING GROUPS:**

Code	Min.	Max.	Unit
е	2.5	2.8	
f	2.8	3.1	V
g	3.1	3.4	

#### Forward Voltage Classifications ( $I_F = 20mA$ ):

### Luminous Intensity Classifications (I<sub>F</sub> = 20mA):

Code	Min.	Max.	Unit
W	2000	2500	
Х	2500	3200	
Y	3200	4000	mcd
Z	4000	5200	
а	5200	6800	

#### Dominant Wavelength Classifications ( $I_F = 20mA$ ):

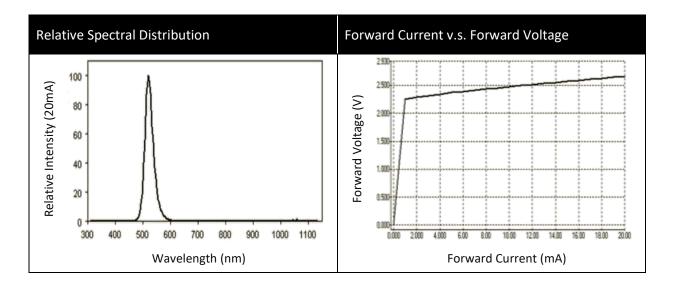
Code	Min.	Max.	Unit
S	515	517.5	
Т	517.5	520	2.22
U	520	522.5	nm
V	522.5	525	

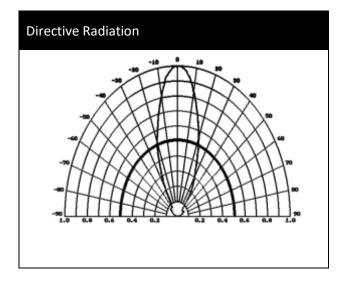
Example Group Name on Label:

• gXT20 = g (3.1~3.4V) ► X (2500~3200mcd) ► T (517.5~520nm) ► 20 (IF=20mA)



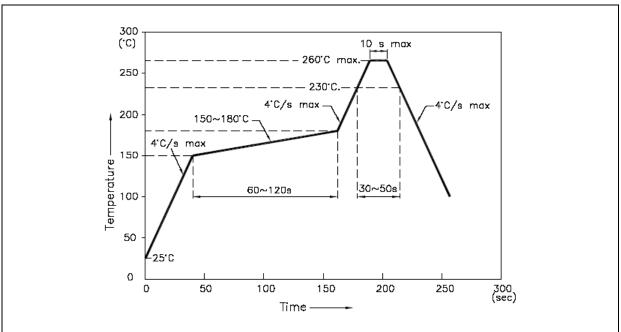
# **ELECTRO-OPTICAL CHARACTERISTICS:**







# **RECOMMENDED SOLDERING PROFILE:**



#### Reflow Solder:

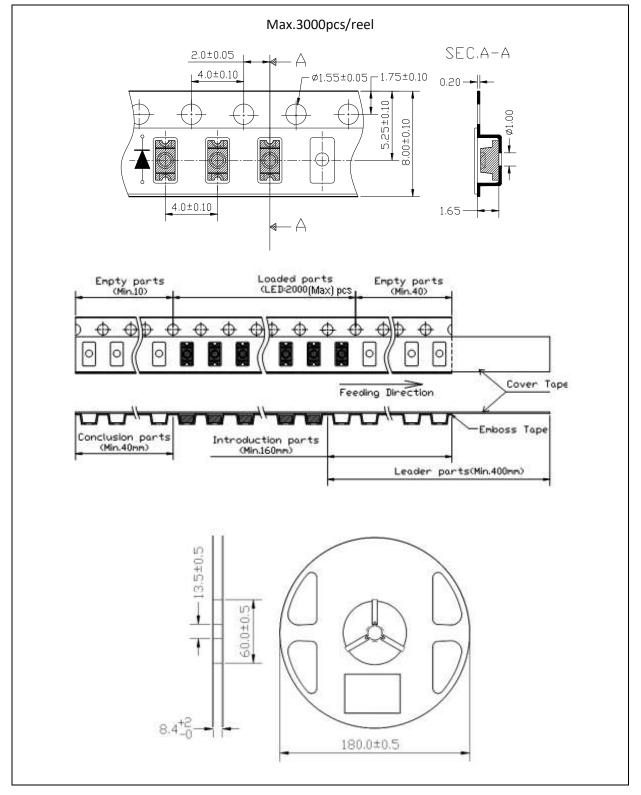
Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to 250°C.
- 2. Maxima reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



# PACKING SPECIFICATION:

#### **Reel Dimension:**



# **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

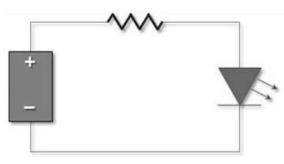
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	10/02/2022	Datasheet set-up.